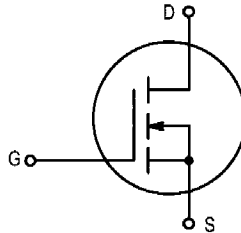
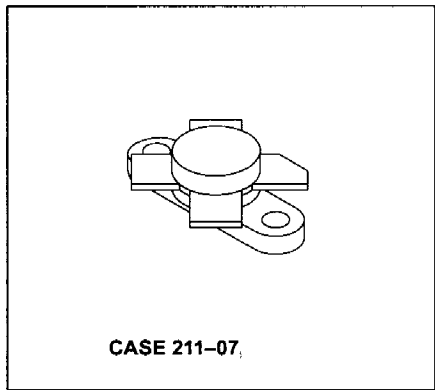
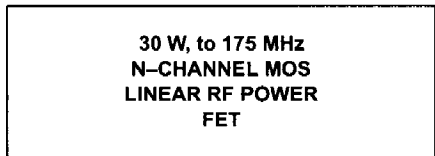


**The RF MOSFET Line**  
**RF Power Field-Effect Transistor**  
**N-Channel Enhancement-Mode**

Designed for power amplifier applications in industrial, commercial and amateur radio equipment to 175 MHz.

- Superior High Order IMD
- Specified 50 Volts, 30 MHz Characteristics  
Output Power = 30 Watts  
Power Gain = 18 dB (Typ)  
Efficiency = 40% (Typ)
- $IMD_{(d3)}$  (30 W PEP) — -35 dB (Typ)
- $IMD_{(d11)}$  (30 W PEP) — -60 dB (Typ)
- 100% Tested For Load Mismatch At All Phase Angles With 30:1 VSWR



**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	120	Vdc
Drain-Gate Voltage	$V_{DGO}$	120	Vdc
Gate-Source Voltage	$V_{GS}$	±40	Vdc
Drain Current — Continuous	$I_D$	6.0	Adc
Total Device Dissipation @ $T_C = 25^\circ C$ Derate above 25°C	$P_D$	115 0.66	Watts W/°C
Storage Temperature Range	$T_{stg}$	-65 to +150	°C
Operating Junction Temperature	$T_J$	200	°C

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.52	°C/W

**Handling and Packaging** — MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.



NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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**OFF CHARACTERISTICS**

Drain-Source Breakdown Voltage ( $V_{GS} = 0, I_D = 10 \text{ mA}$ )	$V_{(BR)DSS}$	125	—	—	Vdc
Zero Gate Voltage Drain Current ( $V_{DS} = 50 \text{ V}, V_{GS} = 0$ )	$I_{DSS}$	—	—	1.0	mAdc
Gate-Body Leakage Current ( $V_{GS} = 20 \text{ V}, V_{DS} = 0$ )	$I_{GSS}$	—	—	100	nAdc

**ON CHARACTERISTICS**

Gate Threshold Voltage ( $V_{DS} = 10 \text{ V}, I_D = 10 \text{ mA}$ )	$V_{GS(th)}$	1.0	3.0	5.0	Vdc
Drain-Source On-Voltage ( $V_{GS} = 10 \text{ V}, I_D = 2.5 \text{ A}$ )	$V_{DS(on)}$	1.0	3.0	5.0	Vdc
Forward Transconductance ( $V_{DS} = 10 \text{ V}, I_D = 2.5 \text{ A}$ )	$g_{fs}$	0.8	1.2	—	mhos

**DYNAMIC CHARACTERISTICS**

Input Capacitance ( $V_{DS} = 50 \text{ V}, V_{GS} = 0, f = 1.0 \text{ MHz}$ )	$C_{iss}$	—	50	—	pF
Output Capacitance ( $V_{DS} = 50 \text{ V}, V_{GS} = 0, f = 1.0 \text{ MHz}$ )	$C_{oss}$	—	35	—	pF
Reverse Transfer Capacitance ( $V_{DS} = 50 \text{ V}, V_{GS} = 0, f = 1.0 \text{ MHz}$ )	$C_{rss}$	—	8.0	—	pF

**FUNCTIONAL TESTS (SSB)**

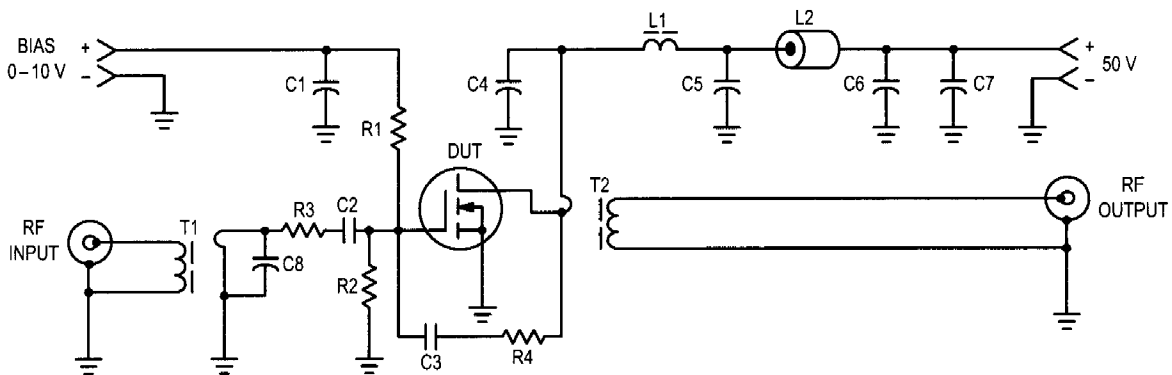
Common Source Amplifier Power Gain ( $V_{DD} = 50 \text{ V}, P_{out} = 30 \text{ W (PEP)}, I_{DQ} = 100 \text{ mA}$ )	(30 MHz) (175 MHz)	$G_{ps}$	— —	18 15	— —	dB
Drain Efficiency ( $V_{DD} = 50 \text{ V}, f = 30 \text{ MHz}, I_{DQ} = 100 \text{ mA}$ )	(30 W PEP) (30 W CW)	$\eta$	— —	40 50	— —	%
Intermodulation Distortion ( $V_{DD} = 50 \text{ V}, P_{out} = 30 \text{ W (PEP)}, f = 30; 30.001 \text{ MHz}, I_{DQ} = 100 \text{ mA}$ )		IMD(d3) IMD(d11)	— —	-35 -60	— —	dB
Load Mismatch ( $V_{DD} = 50 \text{ V}, P_{out} = 30 \text{ W (PEP)}, f = 30; 30.001 \text{ MHz}, I_{DQ} = 100 \text{ mA}, VSWR 30:1$ at all Phase Angles)		$\psi$	No Degradation in Output Power			

**CLASS A PERFORMANCE**

Intermodulation Distortion (1) and Power Gain ( $V_{DD} = 50 \text{ V}, P_{out} = 10 \text{ W (PEP)}, f_1 = 30 \text{ MHz}, f_2 = 30.001 \text{ MHz}, I_{DQ} = 1.0 \text{ A}$ )		$G_{PS}$ IMD(d3) IMD(d9-13)	— — —	20 -50 -70	— — —	dB
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**NOTE:**

- To MIL-STD-1311 Version A, Test Method 2204B, Two Tone, Reference Each Tone.



C1, C2, C3, C4, C5, C6 — 0.1  $\mu\text{F}$  Ceramic Chip or Equivalent  
 C7 — 10  $\mu\text{F}$ , 100 V Electrolytic  
 C8 — 100 pF Dipped Mica  
 L1 — VK200 20/4B Ferrite Choke or Equivalent (3.0  $\mu\text{H}$ )  
 L2 — Ferrite Bead(s), 2.0  $\mu\text{H}$

R1, R2 — 200  $\Omega$ , 1/2 W Carbon  
 R3 — 4.7  $\Omega$ , 1/2 W Carbon  
 R4 — 470  $\Omega$ , 1.0 W Carbon  
 T1 — 4:1 Impedance Transformer  
 T2 — 1:2 Impedance Transformer

**Figure 1. 2.0 to 50 MHz Broadband Test Circuit**